

Maraian	انسم	10	2025)
(version	April	12,	ZUZOJ

Invited /	Daman #	A				C	Title
Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	Title
Invited	P1	1	Keynote - 1	Allen	Gabor	IBM	IBM Lithography Roadmap and Need for Future Lithography Tools
Invited	P2	1	Keynote - 1	Steven	Carson	Intel	Update on High-NA EUV in process technology development
Invited	P3	1	Keynote - 1	Mark	Gouker	MIT LL	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)
Invited	P4	2	Keynote - 2	Oscar	Versolato	ARCNL	Research & roadmap for future sources of EUV light and beyond (BEUV)
Invited	P5	2	Keynote - 2	Debbie	Gustafson	Energetiq	We Can Make a Difference – How to Promote Women in Technology
Invited	P6	2	Keynote - 2	Junji	Yumoto	University of Tokyo	Development of Next-Generation Semiconductor Process Technologies for EUV and BEUV under Japan's "K Program" for Economic Security by JST
Invited	P7	3	Keynote - 3	Robert	Chau	Natcast	EUV and Non-EUV Based Lithography R&D to Extend Semiconductor Device Scaling and Improve Manufacturing Efficiency
Invited	P8	3	Keynote - 3	Bruce	Smith	RIT	EUV multilayers for high-NA 13.5nm, 11.3nm, and shorter- wavelength EUVL



	(Version April 12, 2025)									
Invited / Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	Title			
		, a ca n								
Invited	P11	4	Mask - 1	Stuart	Sherwin	EUV Tech	EUV Absorber Sidewall Metrology with EUV Scatterometry			
Invited	P12	4	Mask - 1	Yogev	Baruch	Zeiss	Reduction of Wafer Intra-Field Overlay and CDU Residuals via laser processing of EUV Reticles			
Invited	P13	4	Mask - 1	Marcus	Benk	CXRO	Hyper-NA EUV Imaging, and Beyond			
Invited	P14	4	Mask - 1	Luke	Long	EUV Tech	HVM-ready EUV zoneplate microscopy for mask defect review			
Invited	P15	5	Mask - 2	Ron	Levi	Corning	EXTREME ULE® for EUV Lithography reticles			
Submitted	P16	5	Mask - 2	Yunsoo	Kim	Hanyang University	Ion Implantation for Improved Etching and Optical Performance in Next-Generation EUV Mask			
Invited	P17	5	Mask - 2	IKEBE	Yohei	Ноуа	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)			
Invited	P18	5	Mask - 2	Kevin	Lucas	Synopsys	High NA EUV design to mask stitching enablement			



(Ve	rsion	Δnril	12	2025)
(100	121011	Артп	12,	ZUZJ

luovite al /							
Invited /	Dener #	A				Commonse	Title
Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	Title
Invited	P19	5	Mask - 2	Katrina	Rook	Veeco	Advanced Ion Source & Target Developments for EUV Mask Multilayer Deposition
Invited	P21	6	Metrology	Mark	Schattenburg	MIT	High Resolution Imaging and Spectrographic Instruments for 1- 10 nm X-ray Astrophysics
Invited	P22	6	Metrology	Brian	Simonds	NIST	Absolute Traceable Electrical Substitution Radiometers for EUV Wavelengths and Beyond
Invited	P23	6	Metrology	Muharrem	Bayraktar	University of Twente	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)
Submitted	P31	7	Modeling	Kirill	Lezhnin	PPPL	Examining Kinetic Plasma Behavior in EUVL Sources with Particle-In-Cell Simulations
Invited	P32	7	Modeling	lgor	Golovkin	Prism Computations	Plasma Simulations of EUV/x-ray Sources: Radiation Transport and Atomic Physics Models
Invited	P33	7	Modeling	Akira	Sasaki	QST	Atomic model to model EUV emission spectrum and to produce the opacity table of tin
Invited	P41	8	Optics	Vladimir	Liberman	MIT LL	Advanced Blue-X Multilayer Coating Designs Strategies



<i></i>				
(Version	April	12.	2025)	1
(10101011			2020,	1

Invited /							
Submitted	Dapor #	Aroa #	Area Namo	First Name	Last Namo	Company	Title
Submitted	гарег #	Alea #	Alea Maille	First Maine	Last Maine	Company	Title
	D / A					Nikon	Beyond One-Size-Fits-All: Tailoring EUV (and BEUV) Optics for
Invited	P42	8	Optics	Donis	Flagello	Research	HVM Efficiency
						Université	Synthesis and metrology of Cr/Sc-based multilayer mirrors for
Invited	P43	8	Optics	Franck	Delmotte	Paris-Saclay	the water window
							Hyper-NA: an EUV system with a numerical aperture of at least
Invited	P44	8	Optics	Michael	Patra	Carl Zeiss	0.75
Invited	P45	8	Optics	Torsten	Feigl	optiXfab	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)
						· ·	
						University of	
Invited	P46	8	Optics	Marcelo	Ackermann	Twente	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)
			Posist and				
			Patterning				Advancing ELIV Photoresist Development: High-Throughput
Invited	P51	9	1 1	Olea	Kostko	CXRO	Screening of Electron-Induced Chemical Transformations
	101	Ű		Clog			
			Resist and			0	la ser embis es de sudan ser (est ef Oblins es discenses in El IV)
Invited	DEO				Kim	Sungkyunkw	Isomorphic molecular control of SD based inorganic EUV
Invited	P92	9	1.1	wyung- Gli		an University	photoresist for optimized photosensitivity and stability
			Resist and				
			Patterning			Merck/EMD	
Invited	P53	9	1.1	Ralph	Dammel	Electronics	Estimation of Resist Photospeeds for Blue-X Wavelengths



(Version	April	12.	2025)	1
	1011	лріп	12,	ZUZJ	,

Submitted /	Donor #	Aroo #	Area Nama	Eirot Nama	Loot Nama	Compony	Title
Submitted	raper #	Alea #	Area Name	FIISt Maine	Last Maine	Company	Title
			Resist and			Designed	Operation is a list of the state of the Device of forms Atomic
Invited	P55	10	Patterning	Chang-Yong	Nam	Brooknaven National Lab	I aver Deposition Techniques
				onang rong			
			Resist and			Chonnam	Report Developments and an Uneveneted Discovery in Our Tin
Invitod	D56	10	Patterning	Hyun-Dom	loong	National	Recent Developments and an Unexpected Discovery in Our Tin-
IIIvited	FJU	10	1.2	Tiyun-Dam	Jeong	Oniversity	
			Resist and				
		10	Patterning		Maria	0	EUV photoresists with controlled sequences lead to improved
Submitted	P57	10	1.2	Cnenyun	ruan	Cornell	stochastics and the discovery of a novel patterning mechanism
			Resist and				Next-Generation EUV Double Amplification Photoresists From
			Patterning		_	_	Acid-Catalyzed Chain Unzipping
Invited	P58	10	1.2	Rachel	Synder	Dupont	
			Resist and				
			Patterning				
Invited	P59	10	1.2	Nishiki	Fujimaki	Fujifilm	EUV NTD-CAR performance toward high-NA EUVL
			Resist and				
			Patterning	Alex			
Invited	P60	10	1.2	Robinson	Robinson	IM	The Multi-Trigger Resist - EUV Performance Update
			Resist and				
			Patterning				Dry Resist Patterning Readiness Towards High NA EUV
Invited	P61	10	1.2	Anuja	DeSilva	Lam	Lithography
			Resist and				
			Patterning				Advanced Coater/developer Technologies for High-NA EUV
Invited	P62	10	1.2	Congque	Dinh	TEL	Lithography



(Version April 12, 2025)

Invited /							
Submitted /	Dener #	A				Commony	Title
Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	Title
			Resist and				Amorphous Zeolitic imidazolate Framework (aZIF) Films for
			Patterning			John Hopkins	Electron Beam, Extreme UV, and Beyond Extreme UV
Invited	P63	10	1.2	Michael	Tsapatsis	University	Lithography Applications
			Resist and				
			Patterning				Lab-based EUV interference lithography for large-area
Invited	P64	11	1.3	Sascha	Brose	RWTH	nanopatterning towards sub-10 nm resolution
			Posist and				
			Patterning				
Invited	P65	11	1 3	Bruno	LaFontaine	CXRO	ELIV/Lithography at The Center for X-Ray Ontics
Invited	1 00		1.0	Diano		0/I/O	
			Resist and				
	Dee		Patterning		o	N ALT	
Invited	P66	11	1.3	Hank	Smith	MIT	Replacing EUV with X-ZPAL
			Resist and				
			Patterning				Development of a Next-Generation Interference Lithography End
Invited	P67	11	1.3	lacopo	Mochi	PSI	Station at the Swiss Light Source
							Increment of EUV radiation and reduction of ion energy of laser-
						Hokkaido	produced Sn EUV-light-source plasmas by controlling initial
Invited	P71	12	Source 1	Kentaro	Tomita	University	plasma structure using multiple pre-pulse laser irradiations
						Kyuchu	Plasma Dynamics and Euture of LPP ELIV Source for
Invited	P72	12	Source 1	Hakaru	Mizoquchi	university	Semiconductor Manufacturing IV
IIIVILEU	172	12				university	
	DT 0					- (
Invited	P73	12	Source 1	Jens	Brunne	Trumpt	The path towards 1.5kW EUV with the CO2 drive laser



(Version	April	12,	2025)	

Invited /							
Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	Title
Submitted	P74	12	Source 1	Hideyuki	Sera	Ushio	Diagnostics of Laser-assisted Discharge Tin Plasma EUV source using collective Thomson scattering
Submitted	P75	13	Source 2	Yosuke	Honda	KEK	The Must Light Source
Invited	P76	13	Source 2	Yusuke	Teramoto	Ushio	A compact laser-driven short-wavelength radiation source
Invited	P77	13	Source 2	Takeshi	Higashiguchi	Utsunomiya University	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)
Submitted	P78	13	Source 2	Jingquan	Lin	University of Science and Technology,	Enhancement of spectral performance in gadolinium-based BEUV sources
Invited	P79	13	Source 2	David	Reisman	Energetiq	SXR development for metrology, inspection, and process control using a discharge-produced plasma source
Invited	P80	13	Source 2	Jochen	Viekers	ILT	Laser-driven x-ray generation for industrial applications
Invited	P81	14	Source 3	Christian	Gaida	Active Fiber Systems GmbH	2µm fiber laser systems for next generation EUV plasma sources



Warsian	۸nril	12	2025)
(version	April	12,	ZUZOJ

Invited /							
Submitted	Papor #	Aroa #	Aroa Namo	Eirst Namo	Last Namo	Company	Title
Submitted	гарег #	Alea #	Alea Maille	First Maine	Last Maine	Company	
Invited	P82	14	Source 3	Jackson	Williams	LLNL	EUV and plasma sources using high energy solid state $\lambda\approx 2~\mu m$ laser drivers
Invited	P83	14	Source 3	Peter	Moulton	MIT LL	Solid state laser drivers for EUV plasma sources
Invited	P84	15	Source 4	Dong Gun	Lee	E-Sol	Why High-Order Harmonic Generation Is the Optimal Source Solution for EUV Mask Review Systems
Invited	P85	15	Source 4	Peter	Kraus	ARCNL	High-Harmonic Generation driven Extreme-Ultraviolet Scatterometry for Nanostructure Characterization
Submitted	P86	15	Source 4	Bastian	Manschwetus	Class 5 Photonics	High repetition rate, high average power XUV sources based on High Harmonic Generation
Invited	P87	15	Source 4	Henry	Keptyn	K&M Labs	Nanoscale Metrologies using Coherent EUV Sources
Invited	P91	16	Supplier Showcase	Henry	Chou	Energetiq	Cost- Effective EUV Light Sources for High-Volume Manufacturing
Invited	P92	16	Supplier Showcase	Matt	Hettermann	EUV Tech	Applications of EUV Metrology Tools



(Version April 1	12.	2025)

Invited /	D #	.	A			0	Title
Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	litte
Submitted	P93	16	Supplier Showcase	Jose	Fonseca	FS Dynamics	Numerical simulations for accelerating productivity and equipment design in semiconductor manufacturing
Invited	P94	16	Supplier Showcase	Victor	Soltwisch	РТВ	About X-ray metrology and the aftermath
Invited	P95	16	Supplier Showcase	Andreas	Biermanns - Foeth	Research Instruments	Tools and solutions for actinic EUV metrology
Invited	P96	16	Supplier Showcase	Jacqueline	van Veldhoven	TNO	Studying the interaction of EUV and plasma with scanner construction materials
Invited	P97	16	Supplier Showcase	Meng	Lee	Veeco	2025 EUV and Source Workshop Invited Talk (Tentatiive Title)
Submitted	P101	17	Poster	Soyeong	Нео	Chonnam National University	Synthesis, Characterizations, and Ligand Substitution of a Non- Alkyl Tin Oxo Cluster as an Inorganic Resist for EUV Lithography
Submitted	P102	17	Poster	Seung-Yong	Baek	Chonnam National University	Improved Sensitivity of CNU-TOC-01(4C-C), a Tin-Oxo Cluster- Based EUV Inorganic Resist, via Position-Selective Purification
Submitted	P103	17	Poster	Wonchul	Kee	Chonnam National University	Development of a Monomeric Inorganic Resist (CNU-TIDO-AA) for EUV Lithography



(Version	Anril	12	2025
(version	April	12,	ZUZJ

		-					
Invited /				-			Title
Submitted	Paper #	Area #	Area Name	First Name	Last Name	Company	litie
Submitted	P104	17	Poster	Gahyun	Lee	Chonnam National University	Synthesis and Evaluation of Function-Integrated Inorganic Molecular Resists for EUV Lithography
Submitted	P105	17	Poster	Alessandro	Ruocco	FS Dynamics	Numerical simulations application in semiconductor manufacturing
Submitted	P106	17	Poster	Jochen	Viekers	ILT	Platform to study effects of EUV-induced plasmas
Submitted	P107	17	Poster	Alec	Griffith	PPPL	Laser Diagnostics for EUVL Sources at Princeton Plasma Physics Laboratory
Submitted	P108	17	Poster	Akira	Miyake	Toyama	The development of EUV and soft X-ray optical evaluation systems in TOYAMA
Submitted	P109	17	Poster	Henry	Chou	Energetiq	Energetiq New Products Poster (Tentative Title)